



60V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)}	I _D T _C = +25°C (Note 10)
60V	$8m\Omega$ @ $V_{GS} = 10V$	100A
	$12m\Omega$ @ $V_{GS} = 4.5V$	85A

Features

- Rated to +175°C Ideal for High Ambient Temperature **Environments**
- 100% Unclamped Inductive Switching (UIS) Test in Production -Ensures More Reliable and Robust End Application
- Low $R_{DS(ON)}$ Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free, "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Description and Applications

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

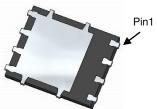
- **Engine Management Systems**
- **Body Control Electronics**
- DC-DC Converters

Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)

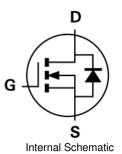


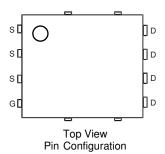




Bottom View

PowerDI5060-8





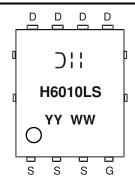
Ordering Information (Note 5)

-		
Part Number	Case	Packaging
DMTH6010LPSQ-13	PowerDI5060-8	2,500 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



☐ ☐ Manufacturer's Marking H6010LS = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 19 = 2019) WW = Week Code (01 to 53)

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Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V_{DSS}	60	٧	
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current (Note 6)	$T_A = +25$ °C $T_A = +70$ °C	l _D	13.5 10.4	Α
Continuous Drain Current (Notes 7 & 10)	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	I _D	100 75	Α
Maximum Continuous Body Diode Forward Current (Note 7)		I _S	100	Α
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%)		I _{DM}	400	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		I _{SM}	400	Α
Avalanche Current, L=0.1mH		I _{AS}	20	Α
Avalanche Energy, L=0.1mH		Eas	20	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	P_{D}	2.6	W
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	57	°C/W	
Total Power Dissipation (Note 7) $T_C = +25^{\circ}C$		P_{D}	136	W
Thermal Resistance, Junction to Case (Note 7)		Rejc	1.1	°C/W
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	-	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}		I	1	μΑ	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	1	1	3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	В	-	6.4	8	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-nesistance	R _{DS(ON)}	_	8.3	12	11122	$V_{GS} = 4.5V, I_D = 20A$	
Diode Forward Voltage	V _{SD}	_	0.8	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	-	2,090	_		V _{DS} = 30V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	-	746	_	pF		
Reverse Transfer Capacitance	C_{rss}	_	38.5	_		I = I IVII IZ	
Gate Resistance	R_g	0.2	0.59	1.5	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	19.3	_			
Total Gate Charge (V _{GS} = 10V)	Q_{g}	-	41.3	_	nC	V 20V I 20A	
Gate-Source Charge	Q_{gs}	_	6	_	IIC	$V_{DS} = 30V, I_{D} = 20A$	
Gate-Drain Charge	Q_{gd}	_	8.8				
Turn-On Delay Time	t _{D(ON)}	_	5.7	_		$V_{DD} = 30V, V_{GS} = 10V,$ $I_{D} = 20A, R_{G} = 3\Omega$	
Turn-On Rise Time	t _R	_	4.3	_			
Turn-Off Delay Time	t _{D(OFF)}	_	23.4	_	ns		
Turn-Off Fall Time	t _F	_	9.7	_			
Body Diode Reverse Recovery Time	t _{RR}		35.4		ns	I_ 2014 di/dt 1004/us	
Body Diode Reverse Recovery Charge	Q _{RR}	_	38.2	_	nC	l _F = 20A, di/dt = 100A/μs	

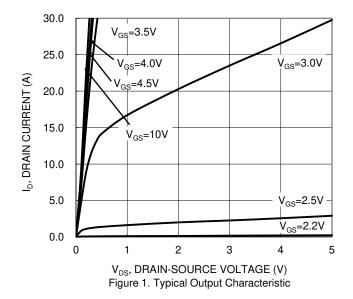
6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

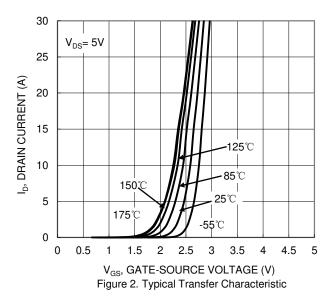
7. Thermal resistance from junction to soldering point (on the exposed drain pad).

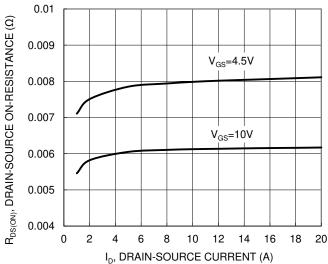
^{8.} Short duration pulse test used to minimize self-heating effect.
9. Guaranteed by design. Not subject to product testing.
10. Limited by package.











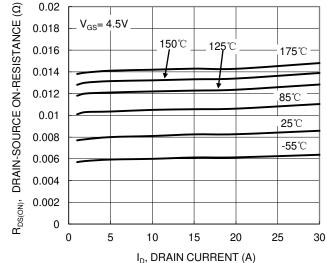
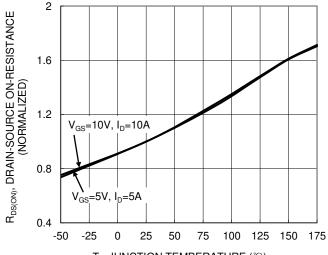
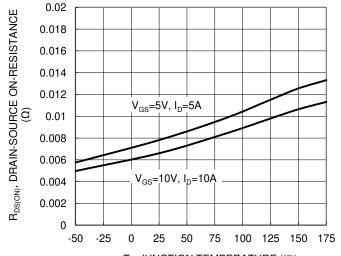


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

Figure 4. Typical On-Resistance vs. Drain Current and Temperature



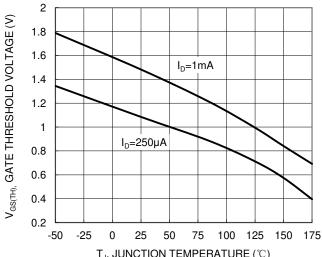


 T_J , JUNCTION TEMPERATURE ($^{\circ}$ C) Figure 5. On-Resistance Variation with Temperature

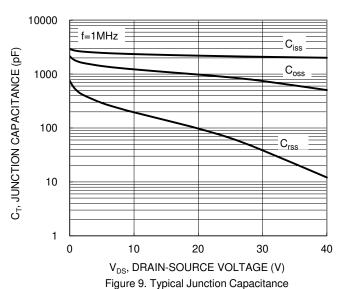
 T_J , JUNCTION TEMPERATURE (°C) Figure 6. On-Resistance Variation with Temperature







 T_J , JUNCTION TEMPERATURE ($^{\circ}$ C) Figure 7. Gate Threshold Variation vs. Junction Temperature



1000 $R_{DS(ON)}$ LIMITED 100 ID, DRAIN CURRENT (A) 10 1 P_W=10m $T_{J(MAX)} = 175$ °C $T_C=25^{\circ}\mathbb{C}$ Single Pulse DC DUT on infinite heatsink V_{GS}=10V 0.01 0.1 100 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 11. SOA, Safe Operation Area

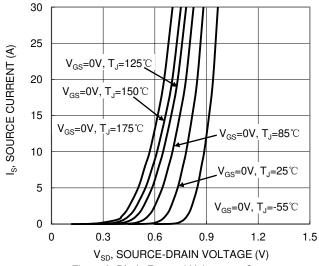
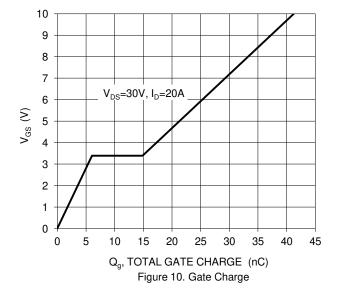


Figure 8. Diode Forward Voltage vs. Current



DMTH6010LPSQ Document number: DS38161 Rev. 3 - 2



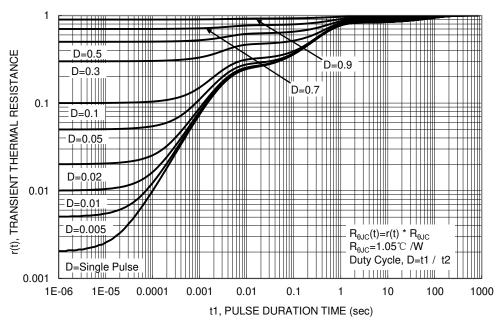


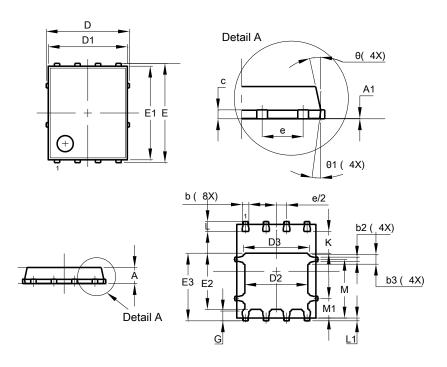
Figure 12. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8

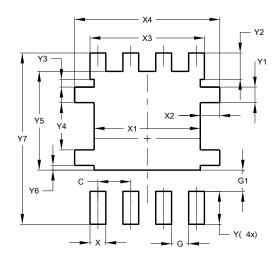


PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A 1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D		5.15 BSC	;		
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
Е	6.15 BSC				
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
М	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
θ	10⁰	12º	11º		
θ1	6º	8º	7º		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
X	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y 7	6.610



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